Introduction

The STPM01 and STPM10 devices are energy meter ASSPs (Application Specific Standard Products) designed to address a wide range of electricity metering requirements thanks to their built-in functionalities as signal conditioning, signal processing, data conversion, input/output signals and voltage reference.

STPM10 is dedicated for peripheral use only in microcontroller based applications, while STPM01 is able to work as a peripheral but also as a standalone device, since it can permanently store configuration and calibration data.

Both the devices have an SPI port to write configuration parameters and read all the information on the line energy from their internal registers.

Measured data (like active, reactive and apparent energy, $V_{\text{RMS}}$, $I_{\text{RMS}}$, instantaneous voltage and current, line frequency, device status etc.) should be read by the microcontroller at a fixed time interval to be further processed.

This application note describes the SPI protocol to read measured data from STPM01 and STPM10 in a single-phase energy meter and how these readings should be processed by the application.

Figure 1. STPMxx based application block diagram
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1 Devices overview

1.1 STPM01

The STPM01 is an ASSP designed for effective measurement of active, reactive and apparent energy in a power line system using Rogowski coil, current transformer and shunt sensors. This device can be implemented as a single chip in single phase energy meters or as a peripheral in microcontroller based meter.

The STPM01 consists, essentially, of two parts: the analog part and the digital part. The former, is composed by preamplifier and 1st order ΔΣ A/D converter blocks, band gap voltage reference, low drop voltage regulator, the latter by system control, oscillator, hard wired DSP and SPI interface.

There is also an OTP block, which is controlled through the SPI by means of a dedicated command set. The configured bits are used for testing, configuration and calibration purpose.

The DSP unit computes active, reactive and apparent energy, RMS and instantaneous values of voltage and current. The results of computation are available as pulse frequency and states on the digital outputs of the device or into the internal data registers, which can be read from the device by means of SPI.

For more details on the device please refer to datasheet.

1.2 STPM10

The STPM10 is designed for effective measurement of active, reactive and apparent energy in a power line system using Current Transformer or Shunt sensors. This device is intended to be a peripheral measurement device in a microcontroller based meter.

The STPM10 consists of an analog part and a digital part. The former, is composed by preamplifier and 1st order ΔΣ A/D converter blocks, Band gap voltage reference, Low drop voltage regulator, the latter by system control, oscillator, hard wired DSP and SPI interface.

Configuration and calibration bits should be set by a microcontroller.

The DSP unit computes active, reactive and apparent energy, RMS and instantaneous values of voltage and current. The results of computation are available in the internal data registers, which can be read from the device by means of SPI.

For more details on the device please refer to datasheet.
2 SPI module description

The STPM01-10 SPI interface supports a simple serial protocol, which is implemented in order to enable a communication between a host system (microcontroller or PC) and the device.

With this interface it is possible to perform the following tasks:
- remote reset of the device,
- temporary programming of internal configuration/calibration data and system signals,
- STPM01 only: permanent programming in OTP memory of internal configuration/calibration data,
- reading of internal data registers (shown in Figure 5).

Four pins of the device are dedicated to this purpose: SCS, SYN, SCL, and SDA.

SCS, SYN and SCL are all input pins while SDA can be input or output according if the SPI is in write or read mode.

The internal registers are not directly accessible, rather a 32 bit of transmission latches are used to pre-load the data before being read or written to the internal registers.

The condition in which SCS, SYN and SCL inputs are set to high level determines the idle state of the SPI interface and no data transfer occurs. Any SPI operation should start from this idle state.
- SCS: enables SPI operation when low.
- SYN: when SCS is low the SYN pin status select if the SPI is in read (SYN=1) or write mode (SYN=0). When SCS is high and SYN is also high the results of the input or output data are transferred to the transmission latches.
- SCL: is the clock pin of the SPI interface. This pin function is also controlled by the SCS status. If SCS is low, SCL is the input of serial bit synchronization clock signal. When SCS is high, SCL is also high determining the idle state of the SPI.
- SDA: is the data pin. If SCS is low, the operation of SDA is dependent on the status of SYN pin. If SYN is high SDA is the output of serial bit data (read mode) if SYN is low SDA is the input of serial bit data signal (write mode). If SCS is high SDA is idle. When SCS is active (low), signal SDA should change its state at trailing edge of signal SCL and the signal SDA should be stable at next leading edge of signal SCL. The first valid bit of SDA is always started with activation of signal SCL.

A high level signal for these pins means a voltage level higher than 0.75 x V\textsubscript{CC}, while a low level signal means a voltage value lower than 0.25 x V\textsubscript{CC}.

2.1 Connection to microcontroller

The SPI master should be implemented by a host system, a PC or a microcontroller.

Microcontrollers SPI bus is usually a four wire bus with full duplex functionality, which signals are usually named as:
- SCLK: Serial Clock (output from master)
- MOSI: Master Output, Slave Input (output from master)
- MISO: Master Input, Slave Output (output from slave)
- SS: Slave Select (active low; output from master)
The best way to connect this standard SPI port to the STPMxx SPI is to have SCS and SYN driven from some general purpose i/o port and SCL and SDA driven from SPI pins.

The suggested connection between microcontroller and STPMxx is the following:
- MISO connected to SDA;
- MOSI not connected;
- SCLK connected to SCL;
- SS connected to SCS;
- a general purpose I/O pin connected to SYN.

In this way the SPI peripheral unit of microprocessor should operate as 2-wire (simplex synchronous transfers) SPI.

The micro SPI peripheral can be used during STPMxx device reading, while during the writing process it is possible to implement the SPI protocol via firmware.

In fact, in real applications with STPM01 the meter is calibrated and configured during meter production, so the main microcontroller task is to read from the device and, more rarely, to reset the device.

In STPM10 based meters the metering device has to be configured at startup from the microcontroller, but also in this case the writing process is done once a while, while reading is a continuous process during meter lifetime.

In both cases, since the reading time is crucial for a correct evaluation of the device data, it is advisable to emulate writing procedure by firmware and to read using SPI peripheral functionality, thus exploiting all the port performances to reach very fast reading.
3 SPI interface timings

Table 1. SPI interface timings

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>$F_{SCLKr}$</td>
<td>Data read speed</td>
<td></td>
<td></td>
<td>32</td>
<td>MHz</td>
</tr>
<tr>
<td>$F_{SCLKw}$</td>
<td>Data write speed</td>
<td></td>
<td></td>
<td>100</td>
<td>kHz</td>
</tr>
<tr>
<td>$t_{DS}$</td>
<td>Data setup time</td>
<td>20</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>$t_{DH}$</td>
<td>Data hold time</td>
<td>0</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>$t_{ON}$</td>
<td>Data driver on time</td>
<td>20</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>$t_{OFF}$</td>
<td>Data driver off time</td>
<td>20</td>
<td></td>
<td></td>
<td>ns</td>
</tr>
<tr>
<td>$t_{SYN}$</td>
<td>SYN active width</td>
<td>$2f_{CLK}$</td>
<td></td>
<td></td>
<td>s</td>
</tr>
</tbody>
</table>

In Table above $f_{CLK}$ is the oscillator clock frequency (see device datasheet for details).
4 SPI operations

4.1 Remote reset request

STPM01 and STPM10 have no reset pin. They are automatically reset by the power on reset (POR) circuit when the \( V_{CC} \) crosses the 2.5 V value but they can be reset also through the SPI interface giving a dedicated command, which timing diagram is shown in Figure 2.

The reset through SPI (remote reset request - RRR) is sent from the on-board microprocessor when some malfunction of metering device has been detected.

Unlike the POR, the RRR signal does not cause the 30 ms retarded restart of analog module and the 120 ms retarded restart of digital module. This reset doesn't clear the mode signals.

Figure 2. Remote reset request timing

Note: All the time intervals must be longer than 30 ns. \( t_7 \rightarrow t_8 \) is the reset time, this interval must be longer than 30 ns as well.

4.2 Data registers writing

Each writable bit (configuration and mode signals bits) of STPM01 and STPM10 has its own 6-bit absolute address (see related datasheets for configuration bits map).

In order to change the state of some pin one must send to STPM01 a byte of data via SPI. This byte consists of 1-bit data to be written (MSB), followed by 6-bit address of destination bit, followed by 1-bit don’t care data (LSB), which makes a command byte.

For example, to set the STPM01 configuration bit 47 (part of the secondary current channel calibrator) to 0, the decimal 47 should be first converted to its 6-bit binary value: \( 101111 \).
The command byte will be then composed like this: 1 bit DATA value + 6-bits address + 1 bit (0 or 1). In this case the binary command will be 01011111 (0x5F) or 01011110 (0x5E).

The writing procedure timing is shown in Figure 3.

**Figure 3.** Timing for writing configuration bits and mode signals

- \( t_1 \rightarrow t_2 (> 30\ \text{ns}) \): SPI out of idle state
- \( t_2 \rightarrow t_3 (> 30\ \text{ns}) \): SPI enabled for write operation
- \( t_3 \): data value is placed in SDA
- \( t_4 \): SDA value is stable and shifted into the device
- \( t_3 \rightarrow t_5 (> 10\ \mu\text{s}) \): writing clock period
- \( t_3 \rightarrow t_5 \): 1 bit data value
- \( t_5 \rightarrow t_6 \): 6 bits address of the destination latch
- \( t_6 \rightarrow t_7 \): 1 bit EXE command
- \( t_8 \): end of SPI writing
- \( t_9 \): SPI enters idle state

Commands for changing configuration bits and system signals should be sent during active signals SCS and SYN as it is shown in Figure 3.

The SYN must be put low in order to disable SDA output driver of the device and make the SDA as an input pin. A string of commands can be send within one period of active signals SCS and SYN or command can be followed by reading the data record but, in this case, the SYN should be deactivated in order to enable SDA output driver and a SYN pulse should be applied before activation of SCS in order to latch the data.

Given the connection between STPMxx and a microcontroller as shown in the previous paragraph, it is possible to implement the writing procedure in the firmware through the following steps:
1. disable the SPI peripheral;
2. set MISO, SCLK and SS to be output;
3. set the pin which is connected to SYN to be output high;
4. activate SCS first and then SYN;
5. activate SCL;
6. apply a bit value to SDA and deactivate SCL;
7. repeat the last two steps seven times to complete one byte transfer;
8. repeat the last three steps for any remaining byte transfer;
9. deactivate SYN and the SCS;
10. enable again the SPI module;

Note: For STPM01 only: To temporary set any bit, it is necessary to set the RD system signal before any other bit. This bit determines the device functioning from OTP shadow latches and not from OTP memory. The procedure to set this signal is that shown above. For permanent writing of any bit see next paragraph.

In case of Precharge command (0xFF), emulation above is not necessary, it can be send before any reading command. In fact, due to the pull up device on the SDA pin the processor needs to perform the following steps:
1. activate SYN first in order to latch the results;
2. after at least 1 µs activate SCS;
3. write one byte to the transmitter of SPI (this will produce 8 pulses on SCL with SDA=1);
4. deactivate SYN;
5. read the data records as shown in paragraph 4.4 (the sequence of reading will be altered);
6. deactivate SCS.
4.3 Data registers permanent writing (STPM01 only)

In order to make a permanent set in OTP memory of some configuration bits, the following procedure should be conducted:
1. collect all addresses of bits to be permanently set into some list;
2. clear all OTP shadow latches;
3. set the system signal RD;
4. connect a current source of at least +14 V, 1 mA to 3 mA to VOTP pin;
5. wait until VOTP voltage is stable;
6. write one of the bit from the list (since RD signal is set, the bit will be written in the corresponding OTP shadow latch);
7. set the system signal WE;
8. wait for 300 µs;
9. clear the system signal WE;
10. clear the OTP shadow latch which was set in step 6;
11. until all wanted bits are permanently set, repeat steps 5 to 11;
12. disconnect the current source;
13. wait until VOTP voltage is less than 3 V;
14. clear the system signal RD;
15. read all data records, in the last two of them there is read back of all configuration bits;
16. if verification of CFG bits fails and there is still chance to pass, repeat steps 1 to 16.

For steps of set or clear apply the timing shown in Figure 3 with proper data on SDA.
For step 15 apply the timing shown in Figure 4.

For permanent set of the TSTD bit, which locks the device, the procedure above must be conducted in such a way that steps 6 to 13 are performed in series during single period of active SCS because the idle state of SCS would make the signal TSTD immediately effective.

This would abort the procedure, and it would possibly destroy the device.

In fact the clearing of system signal RD would connect all gates of 3 V NMOS sense amplifiers of already permanently set bits to the VOTP source.

4.4 Reading data registers

There are two phases of reading, called latching and shifting.

- Latching is used to sample results into transmission latches. This is done with the active pulse on SYN when SCS is idle. The length of pulse on SYN must be longer than 2 periods of measurement clock, i.e. more than 500 ns.
- Shifting starts when SCS become active. In the beginning of this phase another, but much shorter pulse (30 ns) on SYN should be applied. An alternative way is to extend the pulse on SYN into the second phase of reading. Latching and shifting finish at the dotted line in the timing diagram shown in Figure 4.
Figure 4. Timing for reading data registers

<table>
<thead>
<tr>
<th>SCS</th>
<th>SYN</th>
<th>SCL</th>
<th>SDA</th>
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</tbody>
</table>

\[ t_1 \rightarrow t_2: \text{Latching phase. Interval value } > 2 / f_{CLK} \]

\[ t_2 \rightarrow t_3: \text{Data latched, SPI idle. Interval value } > 30 \text{ ns} \]

\[ t_3 \rightarrow t_4: \text{Enable SPI for read operation. Interval value } > 30 \text{ ns} \]

\[ t_4 \rightarrow t_5: \text{Serial clock counter is reset. Interval value } > 30 \text{ ns} \]

\[ t_5 \rightarrow t_6: \text{SPI reset and enabled for read operation. Interval value } > 30 \text{ ns} \]

\[ t_7: \text{Internal data transferred to SDA} \]

\[ t_8: \text{SDA data is stable and can be read} \]

After the shifting phase, it is possible to read data, applying 32 serial clocks per data record. Up to 8 data records can be read this way.

Eight 32-bit data registers in STPM01 store relevant measurement information (see related datasheet for more details). Figure 5 shows the records structure and the information they hold, the default sequence of reading.

The system that reads the data record from the STPM01 should check the integrity of each data record. If the check fails, the reading should be repeated, but this time only the shifting phase should be applied otherwise a new data would be latched into transmission latches and previous reading would be incorrectly lost.
Most of registers hold several distinctive values of certain bit length, except CFL and CFH that are holding a bit map of configurators. Most of values are codified as unsigned integer, except for two values in DMV which are codified as signed binary.

The data records have fixed position of reading. This means that no addressing of records is necessary.
5 Data processing

5.1 Reading process

As told before, to start a SPI communication with STPMxx to read new values of registers, it is necessary to apply a latching phase first. Then a shifting phase starts, as reported in Figure 4.

After that, 32 pulses of serial clocks needs to be applied to pin SCL in order to read the DAP register. If additional 32 pulses are applied to pin SCL, the DRP register is read. At this point there are two possibilities. Either reading is continued by applying 32 clocks per register until all registers of interest are read or a precharge command is applied first (8 pulses to pin SCLNL_C while SYN=0 and SDA=1) which moves an internal read pointer to register DEV which effectively skips DSP and DFP registers, and then reading may be continued.

It is up to an application to decide how many records should be read out from the device.

After all registers are read, SCS can be returned to idle state which ends the shifting phase.

Shifting phase can be repeated and it should read the same values. This repetition is used to improve the reliability of successful reading in a strong EMI environment.

Every register is packed into 4-bytes where the most significant nibble (4 bits) is reserved for parity code and the rest of 28 bits are used for data. This means that every register is protected by its own parity bit.

As shown in Figure 6, the first read out byte of data record is Least Significant Byte (LSB) of data value and the fourth is Most Significant Byte (MSB) of data value, then it is necessary to re-order the four bytes after reading.

![Figure 6. STPMxx data registers](image)

Normally, each byte is read out as most significant bit (MSB) first. But this can be changed by setting the MSBF configuration bit. If this is done, each byte is read out as least significant bit (LSB) first.
5.1.1 Data register assembling example

Following an example of reading and re-arranging of STPMxx registers.

On the left are reported the eight data records as they are read, represented as
hexadecimal bytes while MSBF was cleared, on the right the corresponding register.

1.  65 7A 7C 82                      DAP = 82 7C 7A 65
2.  00 7A 0C E0                      DRP = E0 0C 7A 00
3.  00 00 8C 92                      DSP = 92 8C 00 00
4.  00 06 6E 22                      DFP = 22 6E 06 00
5.  BB B3 07 DD                      DEV = DD 07 B3 BB
6.  3F AF AA CA                      DMV = CA AA AF 3F
7.  01 00 00 E0                      CFL = E0 00 00 01
8.  00 00 00 F0                      CFH = F0 00 00 00

5.2 Parity check

Each bit of parity nibble is defined as odd parity of all seven corresponding bits of data
nibbles. In order to check the data record integrity, the application should execute something
similar to the following C code, given as an example:

```c
int BadParity (unsigned char *bp)
{
    register unsigned char prty;  /* temporary register */
    prty  = *bp,                  /* take the 1st byte of data */
    prty ^= *(bp+1),              /* XOR it with the 2nd byte */
    prty ^= *(bp+2),              /* and with the 3rd byte */
    prty ^= *(bp+3),              /* and with the 4th byte */
    prty ^= prty<<4, prty &= 0xF0; /* combine and remove the lower nibble */
    return (prty != 0xF0);        /* returns 1, if bad parity */
}
```

If the parity nibble check would fail, the reading task should be repeated but, this time,
without request of latching otherwise a new data would be latched and previous reading
would be incorrectly lost.

In a very hash EMI environment, it would be a good practice to read the data records twice
and then compare both reading. This way the probability of detecting bad readings would be
significantly improved. Anyway, a single bad data can be discarded because no meaningful
information is lost as long the reading frequency is about 30 ms.
5.2.1 Parity check example

Let us consider the example of paragraph 5.1.1 to check the parity of the registers:

1. \( DAP = 82\ 7C\ 7A\ 65 \) \( \text{parity}=8 \),
2. \( DRP = E0\ 0C\ 7A\ 00 \) \( \text{parity}=E \),
3. \( DSP = 92\ 8C\ 00\ 00 \) \( \text{parity}=9 \),
4. \( DFP = 22\ 6E\ 06\ 00 \) \( \text{parity}=2 \),
5. \( DEV = DD\ 07\ B3\ BB \) \( \text{parity}=D \),
6. \( DMV = CA\ AA\ AF\ 3F \) \( \text{parity}=C \),
7. \( CFL = E0\ 00\ 00\ 01 \) \( \text{parity}=E \),
8. \( CFH = F0\ 00\ 00\ 00 \) \( \text{parity}=F \).

Most likely, the STPM01 is not responding (is not selected), if any data record is read as:

X. \( FF\ FF\ FF\ FF \) \( \text{parity}=F \), (parity check will fail)

Let's check the parity code of the first data record. The following steps should be performed using temporary variable named HL:

1. load the 1st byte into HL \( \text{HL} = 65 \) \( = 0110\ 0101 \)
2. exor HL with the 2nd byte: \( \text{HL} = 65^{\text{^\text{7A}}} = 0110\ 0101^{\text{^\text{0111\ 1010}}} \)
3. exor HL with the 3rd byte: \( \text{HL} = 1^{\text{^\text{F7C}}} = 0001\ 1111^{\text{^\text{0111\ 1100}}} \)
4. exor HL with the 4th byte: \( \text{HL} = 6^{\text{^\text{382}}} = 0110\ 0011^{\text{^\text{1000\ 0010}}} \)
5. exor HL with HL<<4: \( \text{HL} = E^{\text{^\text{110}}} = 1110\ 0001^{\text{^\text{0001\ 0000}}} \)
6. and HL with 0xF0: \( \text{HL} = F^{\text{^\text{1F}}} = 1111\ 0001^{\text{^\text{&\ 1111\ 0000}}} \)
7. compare HL with 0xF0: \( \text{HL} = F^{\text{^\text{0}}}= 1111\ 0000 \)

This time the parity is not correct.

5.3 Unpacking data

After reading (and following re-ordering of bytes read), each register should be unpacked in order to obtain all individual values.

For this purpose it is necessary to mask the 28 bits according to the registers map shown in Figure 5. For example, DAP register is unpacked into 8-bit value of status (least significant byte) and 20-bit value of active energy counter (remaining upper 3 bytes with parity code masked out).
6 Converting readings into measured values

6.1 Energies

The first four registers contain 20 bit value of internal energy up/down counters.

The value of least significant bit of every energy counter is related to power meter constant \( P \), which is the number of pulses per kWh that the meter, through calibration, is configured to provide to LED pin.

This means that this value changes with the application and relative calibration.

Given \( P \), the value of the LSB of the source energy registers is indicated below:

\[
K_{AW} = \frac{1000}{(2^{11} \cdot P)} \text{ [Wh]} \quad \text{(active energy)}; \\
K_{AWFund} = 4 \cdot K_{AW} \text{ [Wh]} \quad \text{(active fundamental energy)}; \\
K_{RW} = 2 \cdot K_{AW} \text{ [VARh]} \quad \text{(reactive energy)}; \\
K_{SW} = K_{AW} \text{ [VAh]} \quad \text{(apparent energy)}.
\]

For example, if \( P = 64000 \text{ imp/kWh} \):

\[
K_{AW} = 7.63 \times 10^{-6} \text{ Wh} \\
K_{AWFund} = 3.05 \times 10^{-5} \text{ Wh} \\
K_{RW} = 1.52 \times 10^{-5} \text{ VARh} \\
K_{SW} = 7.63 \times 10^{-6} \text{ VAh}
\]

This also means that the STPMxx energy counters hold a very small energy value (in the example above, the active energy register stores about 8 Wh), and further energy integration has to be performed inside the application.

To accomplish this task, the below procedure should be followed.

Because all energy counters rollover in approximately 1 s when they are integrating maximal power, the reading must be done frequently enough. Our suggestion is to read the registers at least 32 times per second.

For each energy type a variable \( e \) should be allocated, having the following structure (below, the variable definition for an ST7 microcontroller):

```c
typedef struct energ {
    unsigned long old;         /* previous energy value - 32 bits */
    unsigned int quot;         /* quant/16 - 16 bits */
    signed int quant;          /* new - old, measure of power - 16 bits */
    signed long frac;          /* fractional part of energy integrator - 32 bits */
    signed long integ;         /* integer part of energy integrator - 32 bits */
} ENERG;
```

The application should keep previous value of each energy counter in order to evaluate the difference of readings, from which also a direction of energy flow can be obtained. This value should be stored in \( e \rightarrow old \) before a reading. After the reading, the new energy register reading should be stored in \( e \rightarrow new \).

To calculate consummated energy the software should implement a 32-bit integrator. The suggested integrator is two stages, with \( e \rightarrow frac \) and \( e \rightarrow integ \) 32-bit signed integer variables. Into \( e \rightarrow frac \) is added the value \( e \rightarrow quant \), obtained as difference between \( e \rightarrow
old and $e \rightarrow \text{new}$ energy values; then $e \rightarrow \text{old}$ value should be rewritten with $e \rightarrow \text{new}$ value in order to enable a correct $e \rightarrow \text{quant}$ computation next time.

When $e \rightarrow \text{frac}$ would collect a certain amount of energy, let say 10 Wh for active energy (corresponding to a certain threshold value according to $K_{AW}$), $e \rightarrow \text{integ}$ should change for 1 bit and the $e \rightarrow \text{frac}$ should change by the threshold value.

This way $e \rightarrow \text{frac}$ stores 0.01 kWh, after which $e \rightarrow \text{integ}$ is increased by one, and $e \rightarrow \text{integ}$ variable will hold accumulated energy of which the least significant bit will represent 10 Wh.

Considering an active energy meter where $P = 64000 \text{ imp/kWh}$, for a step of 0.01 kWh = 10 Wh, since each bit of $e\text{' quant}$ represents $K_{AW}$ Wh (is the same resolution of internal energy counter, because $e \rightarrow \text{quant}$ is calculated as a difference of two energy counter values), the threshold value will be $10 / K_{AW} = 10 * 2^{17} = 0 \times 140000$.

In a microcontroller based application, a high priority timer interrupt should be set to perform measuring tasks every 1/512 s. Within this interrupt service 16 different subtasks could be established in order to broke the whole meter task into 16 shorter consecutive subtasks (reading of device’s register, checking the data read and if OK, computing the value of $e \rightarrow \text{quant}$, ...). In this way the main program and other interrupt services are not blocked for more than few 100 µs every 2 ms, and the meter task will be completed in 16 steps - that is in 1/32 s.

The interrupt service should do the following:
- update $e \rightarrow \text{frac}$ and $e \rightarrow \text{integ}$ of energy variable using $e \rightarrow \text{quot} = e \rightarrow \text{quant} / 16$
- generate output pulses (if needed) from $e \rightarrow \text{frac}$
- call the next subtask
- perform other tasks (if needed)

In this way the addition of $e \rightarrow \text{quant}$ is split in 16 times. This generates a microcontroller output pulse that has a 16 times better accuracy of position in time. In fact the period of reading would be 1/32 s = 31.25 ms. If the whole value of $e \rightarrow \text{quant}$ would be added to the final energy register $e \rightarrow \text{frac}$, only 31.25 ms resolution of output pulse position would be possible, which would be seen as a jitter just by eye looking to the LED. Using suggested method the resolution of output pulse position would be 1.95 ms, which is short jitter enough that nobody would see it.

Below an example of subtasks organization is given:

subtask_0: latch the values in the STPMxx
subtask_1: read the STPMxx
subtask_2: repeat the reading of STPMxx (without latching again) and stop SPI communication
subtask_3: verify the parity codes of registers and equality of both readings, result is flag OK
subtask_4: if OK unpack values of registers read from STPMxx
subtask_5: if OK process STPMxx status
subtask_6: if OK compute $e \rightarrow \text{quant}$ and update $e \rightarrow \text{old}$ of active energy
subtask_7: if OK compute $e \rightarrow \text{quant}$ and update $e \rightarrow \text{old}$ of reactive energy
subtask_8: if OK compute $e \rightarrow \text{quant}$ and update $e \rightarrow \text{old}$ of apparent energy
subtask_9: if OK calculate $V_{rms}$ and $I_{rms}$. 
subtask_A: convert $e \rightarrow \text{integ}$ of active energy into format suitable for LCD
subtask_B: convert $e \rightarrow \text{integ}$ of reactive energy into format suitable for LCD
subtask_C: convert $e \rightarrow \text{integ}$ of apparent energy into format suitable for LCD
subtask_D: convert $V_{\text{rms}}$ into format suitable for LCD
subtask_E: convert $I_{\text{rms}}$ into format suitable for LCD
subtask_F:
if not OK $e \rightarrow \text{quant} = 0$
else {
    $e \rightarrow \text{quot} = e \rightarrow \text{quant} \mod 16$, (is the remainder of $e \rightarrow \text{quant} / 16$)
    update $e \rightarrow \text{frac}$ of active energy using $e \rightarrow \text{quot}$,
    $e \rightarrow \text{quot} = e \rightarrow \text{quant} / 16$
}

6.2 Other values

The ratio between the register value and the actual voltage, current or frequency value is a function of the voltage and current sensors sensitivity and of the device internal parameters, like analog amplification, reference voltage, measurement frequency, calibrator, attenuation of each stage of decimation filter and power meter constant.

Formulas to convert the readings into meaningful values are reported below.

In any case, since the internal parameters values, here given as constants, are subject to process drift, and the sensors sensitivity are subject to tolerance, even if these fluctuations are compensated by the calibrators, the best way to obtain the proper parameters is to measure known signals and calculate the ratio between register value and actual value. The device linearity will ensure that the ratio will remain constant.

*Figure 7, Figure 8 and Figure 9* below shown the signal processing chains for current and voltage.

**Figure 7. Voltage signal path**

![Voltage signal path diagram](image)
Each block of the path contributes to the signal processing with the parameters shown below.

*Table 2* shows the variable parameters that must be considered as inputs for the following calculation while *Table 3* shows device internal constant parameters.

**Table 2. Input parameters**

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Meaning</th>
</tr>
</thead>
<tbody>
<tr>
<td>R1, R2</td>
<td>Voltage Divider Resistors Value [Ohm]</td>
</tr>
<tr>
<td>Ks</td>
<td>Current Sensor Sensitivity Value [V/A]</td>
</tr>
<tr>
<td>x_i_rms</td>
<td>RMS Current Register Value expressed as decimal</td>
</tr>
<tr>
<td>x_u_rms</td>
<td>RMS Voltage Register Value expressed as decimal</td>
</tr>
<tr>
<td>x_i_mom</td>
<td>Momentary Current Register Value expressed as decimal</td>
</tr>
<tr>
<td>x_u_mom</td>
<td>Momentary Voltage Register Value expressed as decimal</td>
</tr>
<tr>
<td>x_f</td>
<td>Frequency Register Value expressed as decimal</td>
</tr>
<tr>
<td>Ai</td>
<td>Current Channel Gain</td>
</tr>
</tbody>
</table>

The value of the current channel gain Ai depends on the selected current sensor. Please refer to the datasheet for the proper value to select.
Line frequency is calculated as follows:

\[
\text{frequency} = 2 \times F_m \times x_f / (\pi \times \text{len}_f \times \text{Dint})
\]

\[
k_f = \text{frequency} / 50
\]

The differentiator and integrator gains are calculated from the frequency result as follows:

\[
K_{\text{dif}} = (2 \times \pi \times \text{frequency} \times \text{Dint}_p) / (2 \times F_m)
\]

\[
K_{\text{int}} = F_m \times 2 / (2 \times \pi \times \text{frequency} \times \text{Dint})
\]

Typical values are:

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Value ( \times )</th>
<th>Meaning</th>
</tr>
</thead>
<tbody>
<tr>
<td>(K_{\text{dif}})</td>
<td>0.6135 (\times)</td>
<td>Gain of differentiator @ line frequency = 50 Hz</td>
</tr>
<tr>
<td>(K_{\text{dif}})</td>
<td>0.7359 (\times)</td>
<td>Gain of differentiator @ line frequency = 60 Hz</td>
</tr>
<tr>
<td>(K_{\text{int}})</td>
<td>0.815 (\times)</td>
<td>Gain of integrator @ line frequency = 50 Hz</td>
</tr>
<tr>
<td>(K_{\text{int}})</td>
<td>0.679 (\times)</td>
<td>Gain of integrator @ line frequency = 60 Hz</td>
</tr>
</tbody>
</table>

Table 3. STPMxx internal parameters value

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Value</th>
<th>Meaning</th>
</tr>
</thead>
<tbody>
<tr>
<td>(K_u)</td>
<td>0.875</td>
<td>Voltage Calibrator Ideal Value</td>
</tr>
<tr>
<td>(K_i)</td>
<td>0.875</td>
<td>Current Calibrator Ideal Value</td>
</tr>
<tr>
<td>(A_u)</td>
<td>4</td>
<td>Voltage Channel Gain</td>
</tr>
<tr>
<td>(\text{len}_i)</td>
<td>(2^{16})</td>
<td>RMS Current Register Length</td>
</tr>
<tr>
<td>(\text{len}_u)</td>
<td>(2^{11})</td>
<td>RMS Voltage Register Length</td>
</tr>
<tr>
<td>(\text{len}_i_mom)</td>
<td>(2^{15})</td>
<td>Momentary Current Register Length</td>
</tr>
<tr>
<td>(\text{len}_u_mom)</td>
<td>(2^{10})</td>
<td>Momentary Voltage Register Length</td>
</tr>
<tr>
<td>(\text{len}_f)</td>
<td>(2^{14})</td>
<td>Frequency Register Length</td>
</tr>
<tr>
<td>(K_{\text{int_comp}})</td>
<td>1.004</td>
<td>Gain of decimation filter</td>
</tr>
<tr>
<td>(\pi)</td>
<td>3.14159</td>
<td></td>
</tr>
<tr>
<td>(D_{\text{int}})</td>
<td>(2^{16})</td>
<td></td>
</tr>
<tr>
<td>(D_{\text{int_p}})</td>
<td>(2^{15})</td>
<td></td>
</tr>
<tr>
<td>(F_m)</td>
<td>(2^{23})</td>
<td>if oscillator frequency is 4.194 or 8.388 MHz</td>
</tr>
<tr>
<td></td>
<td>(8 \times 10^6)</td>
<td>if oscillator frequency is 4.000 or 8.000 MHz</td>
</tr>
<tr>
<td>(K_{ut})</td>
<td>2</td>
<td>for CT/Shunt</td>
</tr>
<tr>
<td></td>
<td>1</td>
<td>for Rogowski coil</td>
</tr>
<tr>
<td>(V_{\text{ref}})</td>
<td>1.23</td>
<td>Internal voltage reference</td>
</tr>
</tbody>
</table>

Typical values are:

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Value</th>
<th>Meaning</th>
</tr>
</thead>
<tbody>
<tr>
<td>(K_{ut})</td>
<td>2</td>
<td>for CT/Shunt</td>
</tr>
<tr>
<td>(K_{ut})</td>
<td>1</td>
<td>for Rogowski coil</td>
</tr>
</tbody>
</table>
For momentary values it is necessary first of all to evaluate their sign:

```c
if (x_i_mom & 0x08000)           // positive current
    x_i_mom = x_i_mom & 0x07FFF;
else                             // negative current
{
    x_i_mom = 0x08000 - x_i_mom;
    x_i_mom = x_i_mom * (-1);
}
```

```c
if (x_u_mom & 0x0400             // positive voltage
    x_u_mom = (x_u_mom) & 0x3FF;
else                             // negative voltage
{
    x_u_mom = 0x0400 - (x_u_mom);
    x_u_mom = x_u_mom * (-1);
}
```

The current and voltage conversion formulas in case of Rogowski Coil current sensor are:

```c
t_u_rms = (1+R1/R2) * x_u_rms *Vref /(Au * Ku * Kint_comp * len_u * Kut)
t_i_rms = x_i_rms * Vref /(Ks * Kf * Ai * Ki * Kint * Kint_comp * len_i)
t_u_mom = (1+R1/R2) * x_u_mom * Vref /(Au * Ku * Kint_comp * len_u_mom * Kut)
t_i_mom = x_i_mom * Vref /(Ks * Kf * Ai * Ki * Kint * Kint_comp * len_i_mom)
```

In case of current trasformer or Shunt sensor the formulas become:

```c
t_u_rms = (1+R1/R2) * x_u_rms *Vref /(Au * Ku * Kint_comp * Kint * Kdif * len_u * Kut)
t_i_rms = x_i_rms * Vref /(Ks * Ai * Ki * Kint * Kint_comp * Kdif * len_i)
t_u_mom = (1+R1/R2) * x_u_mom * Vref /(Au * Ku * Kint_comp * Kint * Kdif * len_u_mom * Kut)
t_i_mom = x_i_mom * Vref /(Ks * Ai * Ki * Kint * Kint_comp * Kdif * len_i_mom)
```
### 7 Revision history

Table 4. Document revision history

<table>
<thead>
<tr>
<th>Date</th>
<th>Version</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>18-Jun-2005</td>
<td>1</td>
<td>First release</td>
</tr>
<tr>
<td>19-Apr-2006</td>
<td>2</td>
<td>Document reformatted no content change</td>
</tr>
<tr>
<td>26-Jul-2010</td>
<td>3</td>
<td>Added: <em>Figure 1 on page 1, Section 1.1</em> and <em>Section 1.2 on page 3</em></td>
</tr>
</tbody>
</table>
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